



FDA20N50 / FDA20N50_F109 500V N-Channel MOSFET

Features

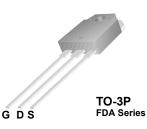
- 22A, 500V, $R_{DS(on)} = 0.23\Omega @V_{GS} = 10 V$
- Low gate charge (typical 45.6 nC)
- Low C_{rss} (typical 27 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability

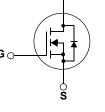


Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.





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Absolute Maximum Ratings

Symbol	Parameter			FDA20N50	Unit
V _{DSS}	Drain-Source Volta	age		500	V
ID	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C	:)	22 13.2	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	88	А
V _{GSS}	Gate-Source voltage			± 30	V
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	1110	mJ
I _{AR}	Avalanche Current		(Note 1)	(Note 1) 22	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	28.0	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20	V/ns
P _D	Power Dissipation $(T_C = 25^{\circ}C)$ - Derate above $25^{\circ}C$			280 2.3	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

* Drain current limited by maximum junction termperature.

Thermal Characteristics

Symbol	Parameter	Min.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.44	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.24		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient		40	°C/W

Device Marking		Device	Pac	ckage	Reel Size Ta		Tape Width		Quantity	
FDA20N50 FDA20N50			TO-3P		· ·			30		
		тс)-3PN					30		
Electric	al Cha	racteristics T _c	= 25°C unle	ss otherwise no	ted					
Symbol	Parameter			Conditions		Min	Тур	Max	Units	
Off Charac	teristics			1						
BV _{DSS}	Drain-So	urce Breakdown Volta	ge	V_{GS} = 0V, I _D = 250µA, T _J = 25°C		500			V	
ΔBV_{DSS} / ΔT_{J}	Breakdov Coefficier	vn Voltage Temperatu nt	re	$I_D = 250 \mu A$, Referenced to 25°C			0.50		V/°C	
I _{DSS}	Zero Gate Voltage Drain Current		V _{DS} = 500V, V _{GS} = 0V V _{DS} = 400V, T _C = 125°C				1 10	μΑ μΑ		
I _{GSSF}	Gate-Boo	ly Leakage Current, F	orward	V _{GS} = 30\	$V_{GS} = 30V, V_{DS} = 0V$				100	nA
I _{GSSR}	Gate-Boo	ly Leakage Current, R	Reverse	$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Charac	teristics			1						
V _{GS(th)}	Gate Thre	e Threshold Voltage		$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0		5.0	V	
R _{DS(on)}		Static Drain-Source Dn-Resistance		V _{GS} = 10V, I _D = 11A			0.20	0.23	Ω	
9 _{FS}	Forward Transconductance		V _{DS} = 40\	/, I _D = 11A	(Note 4)		24.6		S	
Dynamic C	haracteris	stics		•						
C _{iss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance		V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz			2400	3120	pF		
C _{oss}						355	465	pF		
C _{rss}							27		pF	
Switching	Character	istics								
t _{d(on)}	Turn-On	urn-On Delay Time urn-On Rise Time		$V_{DD} = 250V, I_D = 20A$ $R_G = 25\Omega$			95	200	ns	
t _r	Turn-On						375	760	ns	
t _{d(off)}	Turn-Off	Delay Time]		-	100	210	ns	
t _f	Turn-Off	Fall Time				(Note 4, 5)		105	220	ns
Qg	Total Gate	e Charge		V _{DS} = 400V, I _D = 20A V _{GS} = 10V			45.6	59.5	nC	
Q _{gs}	Gate-Sou	Irce Charge					14.8		nC	
Q _{gd}	Gate-Dra	in Charge				(Note 4, 5)		21.6		nC
	rce Diode	Characteristics and	Maximun	n Ratings						
I _S	Maximum	n Continuous Drain-So	ource Dio	de Forward	Current				20	Α
I _{SM}	Maximum	Pulsed Drain-Source	e Diode Fo	orward Current				80	Α	
V _{SD}	Drain-So	urce Diode Forward V	oltage	V _{GS} = 0V, I _S = 22A				1.4	V	
t _{rr}	Reverse	Recovery Time		V _{GS} = 0V,				507		ns
Q _{rr}	Reverse	Recovery Charge		dl _F /dt =100A/μs		(Note 4)		7.20		μC

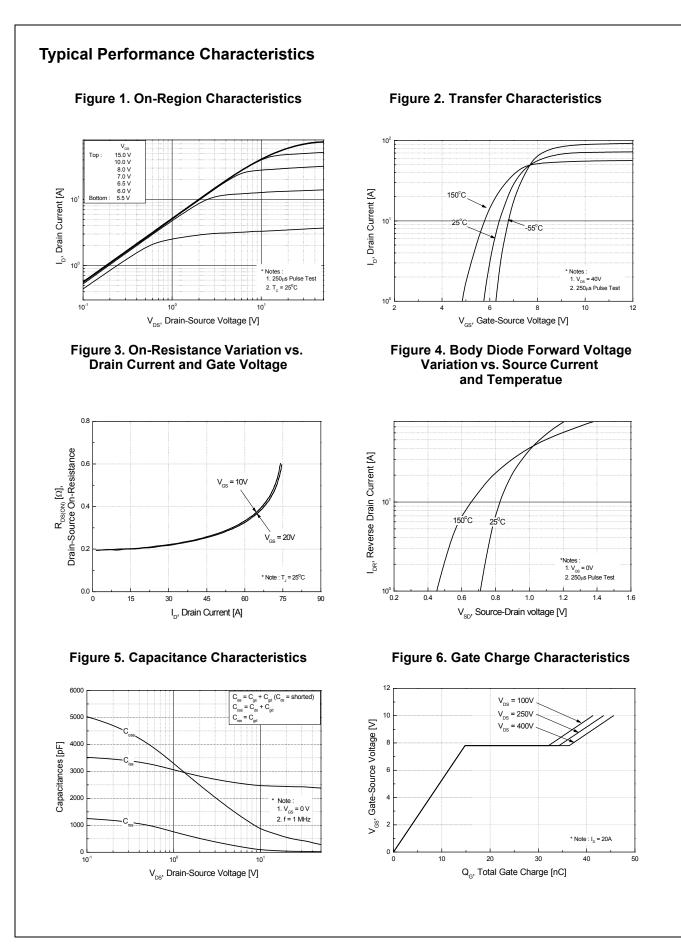
1. Repetitive Rating: Pulse width limited by maximum junction temperature

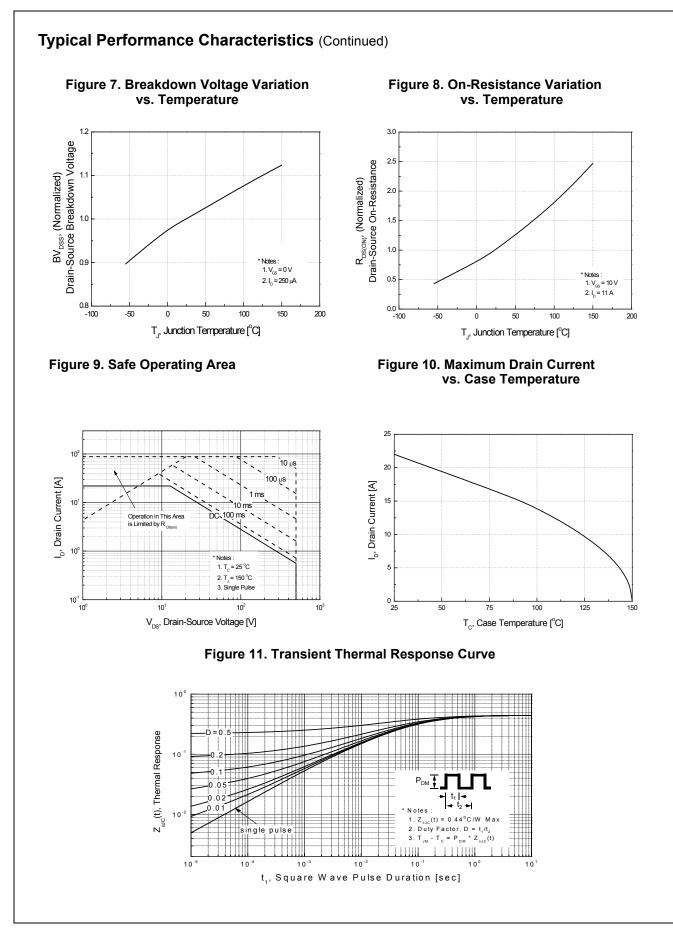
2. L = 4.1mH, I_{AS} = 22A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

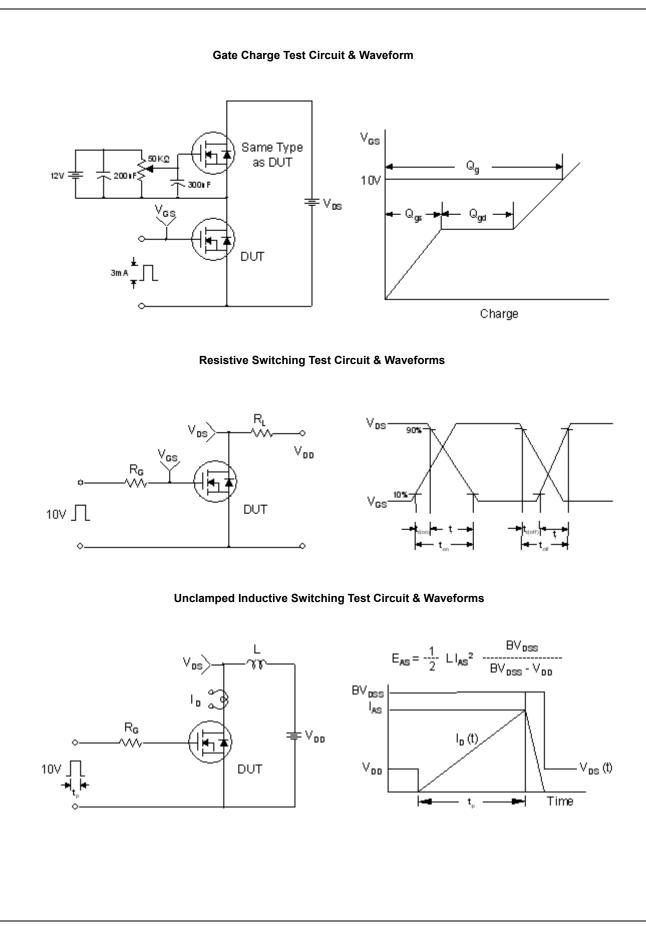
3. $I_{SD} \leq$ 22A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS},$ Starting T_J = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics

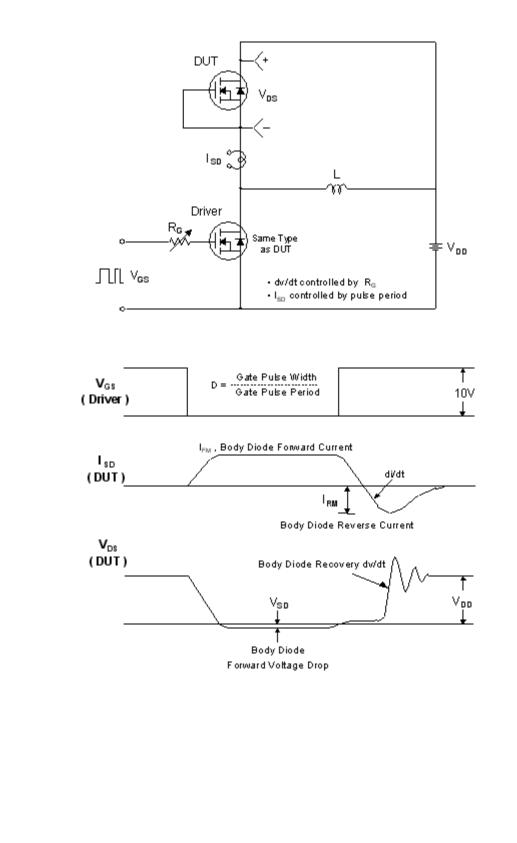


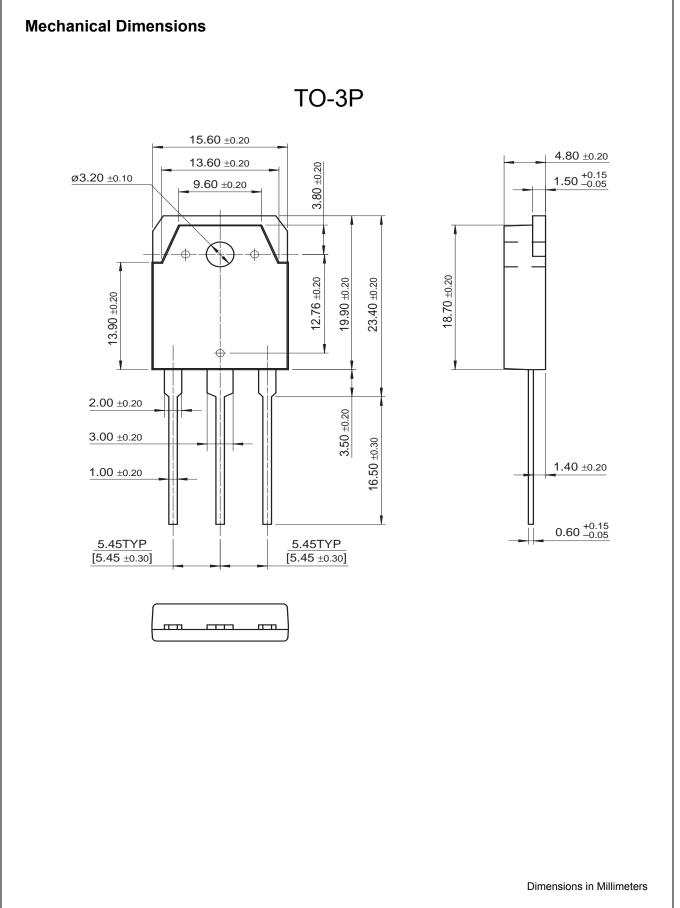


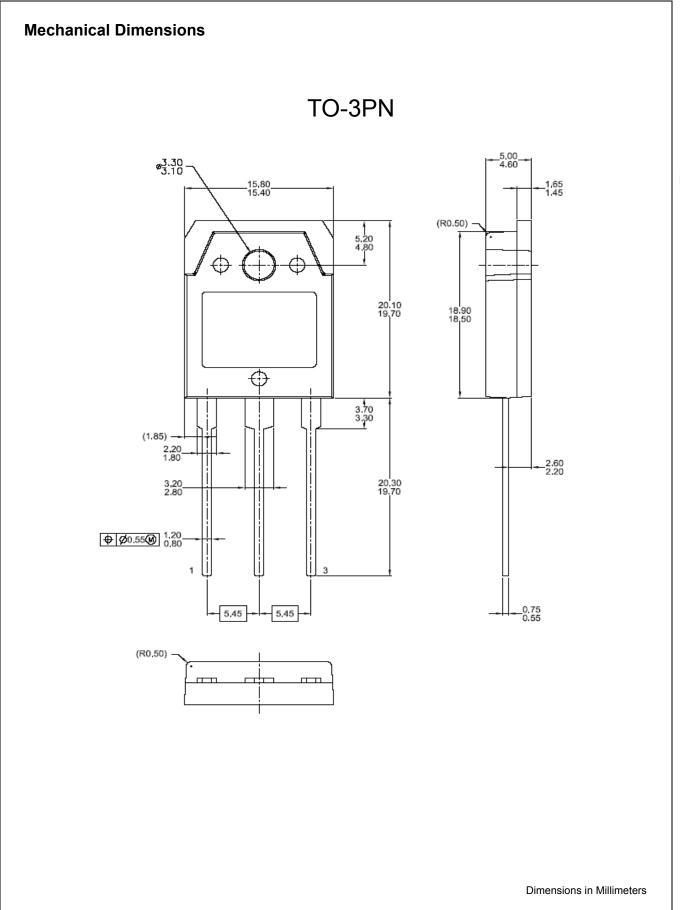


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